

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Khai Huat Jeffrey Low</td><td>08/22/2008</td></tr><tr><td>Chai Wei Heng</td><td>08/22/2008</td></tr><tr><td>Wae Chet Yong</td><td>08/22/2008</td></tr></tbody></table>		Name	Execution Date	Khai Huat Jeffrey Low	08/22/2008	Chai Wei Heng	08/22/2008	Wae Chet Yong	08/22/2008
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Khai Huat Jeffrey Low	08/22/2008								
Chai Wei Heng	08/22/2008								
Wae Chet Yong	08/22/2008								
RECEIVING PARTY DATA									
Name:	Infineon Technologies AG								
Street Address:	Am Campeon 1-12								
City:	Neubiberg								
State/Country:	GERMANY								
Postal Code:	85579								
PROPERTY NUMBERS Total: 1									
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12145832</td></tr></tbody></table>		Property Type	Number	Application Number:	12145832				
Property Type	Number								
Application Number:	12145832								
CORRESPONDENCE DATA									
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ATTORNEY DOCKET NUMBER:	3002.0227C								
NAME OF SUBMITTER:	Patrick J. Finnan								
Total Attachments: 2 source=ExecutedAssignment#page1.tif									

OP \$40.00 12145832

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PATENT  
REEL: 021530 FRAME: 0445



### ASSIGNMENT

For good and valuable consideration, WE, Khai Huat Jeffrey Low, a citizen of Malaysia, residing at 99 Jalan Sentosa 1, Taman Sentosa, 75150 Melaka, Malaysia; Chai Wei Heng, a citizen of Malaysia, residing at 569, Jalan Utama, Air Keroh Heights, 75450 Melaka, Malaysia; and Wae Chet Yong, a citizen of Malaysia, residing at 31, Jln PPP5, Taman, Permatang Pasir Permai, 75460 Melaka, Malaysia, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to Infineon Technologies AG, a corporation organized and existing under the laws of Germany, having its principal place of business at Am Campeon 1-12, 85579 Neubiberg, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on June 25, 2008 as US. Application Serial No. 12/145,832,

entitled: Electronic Component and a Method of Fabricating an Electronic Component

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements on the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE: \_\_\_\_\_

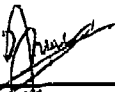
Khai Huat Jeffrey Low

DATE: \_\_\_\_\_

72/8/08

REF NO. FIN 805  
O.C. REF NO. 3002.0227C

SIGNATURE:



DATE:

22/8/08

Chai Wei Heng

SIGNATURE:



DATE:

02/8/08

Wae Cher Yong